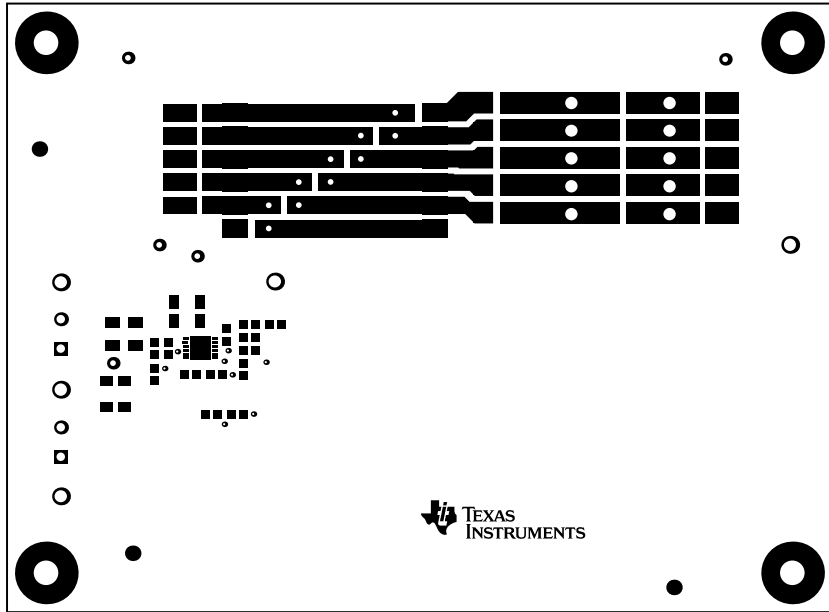
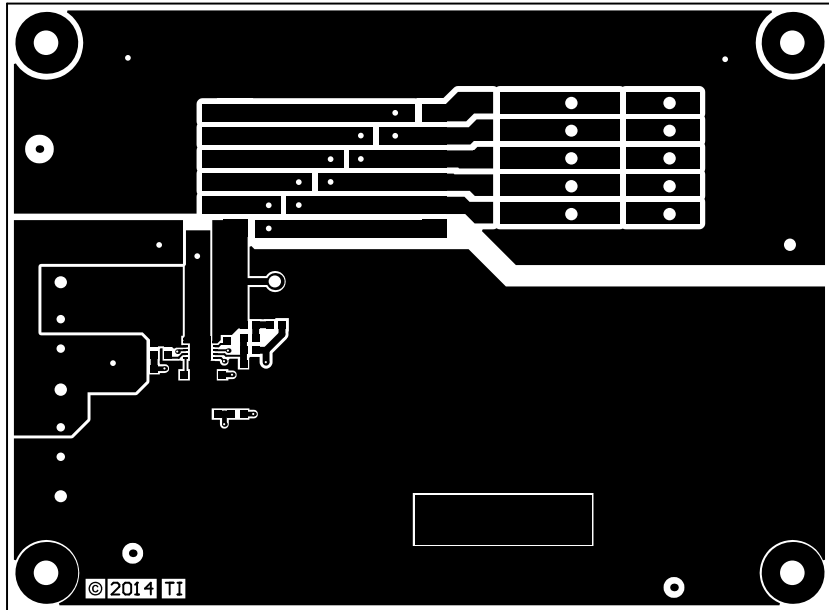


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10559	REV: Rev2	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 2/13/2015 11:00:01 AM	TEXAS INSTRUMENTS	

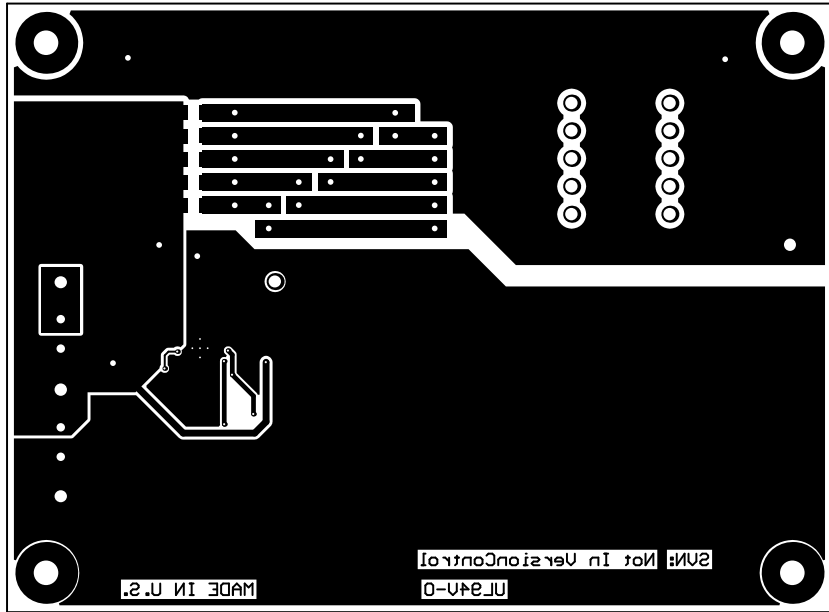


 TEXAS
INSTRUMENTS

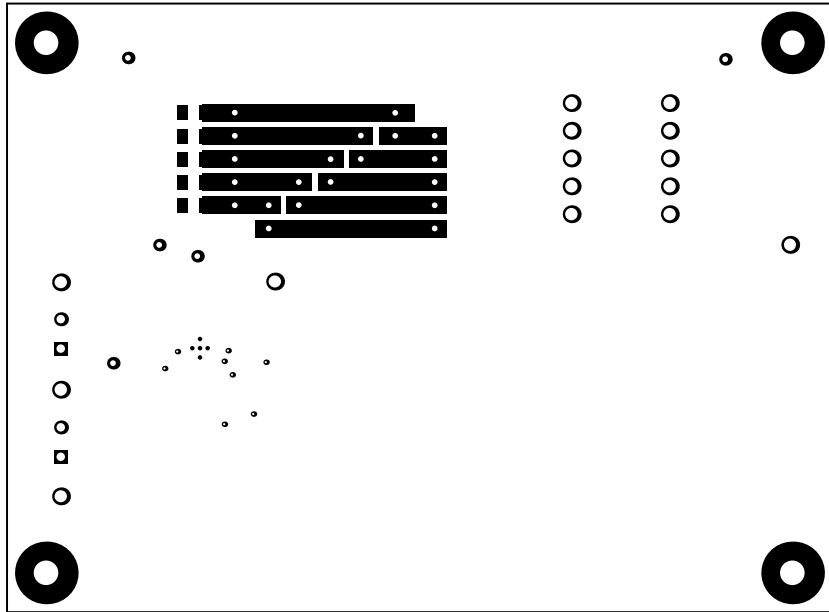
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10559	REV: Rev2	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 2/13/2015 11:00:01 AM	TEXAS INSTRUMENTS	



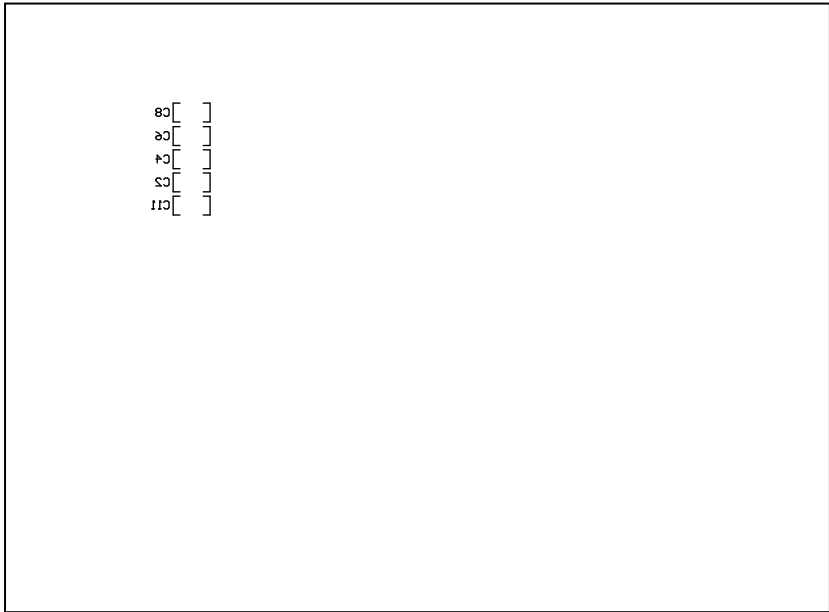
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10559	REV: Rev2	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 2/13/2015 11:00:02 AM	TEXAS INSTRUMENTS	



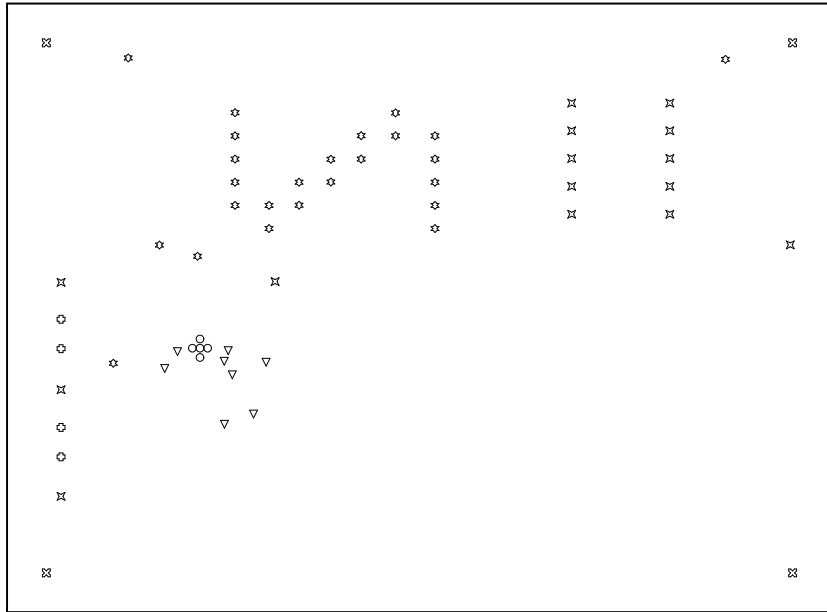
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10559	REV: Rev2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 2/13/2015 11:00:03 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10559	REV: Rev2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 2/13/2015 11:00:03 AM	TEXAS INSTRUMENTS	



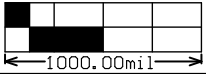
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10559	REV: Rev2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 2/13/2015 11:00:04 AM	TEXAS INSTRUMENTS	



Symbol	Hit Count	Tool Size	Plated	Hole Type
○	5	10mil (0.254mm)	PTH	Round
▽	8	12mil (0.305mm)	PTH	Round
*	25	30mil (0.762mm)	PTH	Round
⊕	4	43.307mil (1.1mm)	PTH	Round
×	15	63mil (1.6mm)	PTH	Round
⊗	4	125.984mil (3.2mm)	PTH	Round
	61 Total			

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10559	REV: Rev2	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 2/13/2015 11:00:05 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10559	REV: Rev2	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 2/13/2015 11:00:05 AM	TEXAS INSTRUMENTS	

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